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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# **N-Channel Power MOSFET**

600V, 78A, 41mΩ

#### **FEATURES**

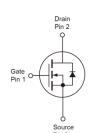
- Super-Junction technology
- High performance, small R<sub>DS(ON)</sub>\*Q<sub>g</sub> figure of merit (FOM)
- High ruggedness performance
- 100% UIS and R<sub>g</sub> tested
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PERFORMANCE PARAMETERS			
PARAMETER	VALUE UNI		
$V_{DS}$	600	V	
R <sub>DS(on)</sub> (max)	41	mΩ	
$Q_g$	139	nC	

#### **APPLICATIONS**

- PFC Stage
- Server/Telecom Power
- Charging Station
- Inverter
- Power Supply





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	600	V
Gate-Source Voltage		$V_{GS}$	±30	V
Continuous Drain Current (Note 1)	$T_C = 25^{\circ}C$		78	Α
	$T_C = 100$ °C	I <sub>D</sub>	49	Α
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	234	Α
Total Power Dissipation @ T <sub>C</sub> = 25°C	0	P <sub>D</sub>	446	W
Single Pulse Avalanche Energy (Note	3)	E <sub>AS</sub>	1122	mJ
Single Pulse Avalanche Current (Note	: 3)	I <sub>AS</sub>	6.7	Α
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction to Case Thermal Resistance	R <sub>eJC</sub>	0.28	°C/W	
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	42	°C/W	

**Thermal Performance Note:**  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\Theta JA}$  is guaranteed by design while  $R_{\Theta CA}$  is determined by the user's board design.

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ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV <sub>DSS</sub>	600			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	2	3	4	V
Gate Body Leakage	$V_{GS} = \pm 30 V$ , $V_{DS} = 0 V$	I <sub>GSS</sub>			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 600V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Drain-Source On-State Resistance (Note 4)	V <sub>GS</sub> = 10V, I <sub>D</sub> = 21.7A	R <sub>DS(on)</sub>		38	41	mΩ
Dynamic (Note 5)		1		1	•	•
Total Gate Charge		$Q_g$		139		
Gate-Source Charge	$V_{DS} = 480V, I_D = 65A,$ $V_{GS} = 10V$	$Q_gs$		41		nC
Gate-Drain Charge		$Q_{gd}$		52		
Input Capacitance		C <sub>iss</sub>		6120		
Output Capacitance	$V_{DS} = 100V, V_{GS} = 0V,$ f = 1.0MHz	C <sub>oss</sub>		276		pF
Reverse Transfer Capacitance	1 = 1.0IVIMZ	C <sub>rss</sub>		43		
Gate Resistance	f = 1.0MHz	$R_g$		4.6	9.2	Ω
Switching (Note 6)						
Turn-On Delay Time		t <sub>d(on)</sub>		107		
Turn-On Rise Time	$V_{DD} = 300V, R_{GEN} = 5\Omega,$	t <sub>r</sub>		152		
Turn-Off Delay Time	$I_D = 32.5A, V_{GS} = 10V$	t <sub>d(off)</sub>		445		ns
Turn-Off Fall Time		t <sub>f</sub>		148		
Source-Drain Diode						
Body-Diode Continuous Forward Cur	rent	I <sub>S</sub>			78	Α
Body-Diode Pulsed Current		I <sub>SM</sub>			234	Α
Forward Voltage (Note 4)	$I_{S} = 65A, V_{GS} = 0V$	$V_{SD}$			1.4	V
Reverse Recovery Time	I <sub>S</sub> = 32.5A	t <sub>rr</sub>		478		ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	$Q_{rr}$		10		μC

#### Notes:

- 1. Current limited by package.
- 2. Pulse width limited by the maximum junction temperature.
- 3. L = 50mH,  $I_{AS} = 6.7A$ ,  $V_{DD} = 50V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^{\circ}C$
- 4. Pulse test: PW  $\leq$  300 $\mu$ s, duty cycle  $\leq$  2%.
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

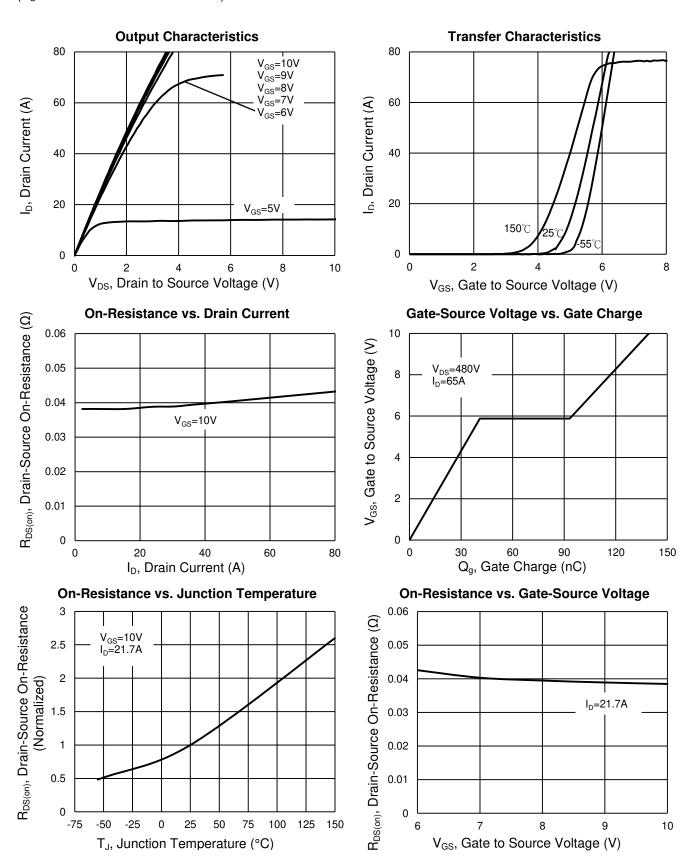
# **ORDERING INFORMATION**

PART NO.	PACKAGE	PACKING
TSM60NB041PW C1G	TO-247	25pcs / Tube



#### **CHARACTERISTICS CURVES**

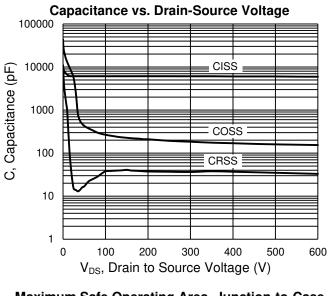
 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

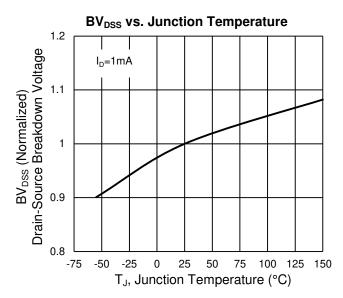


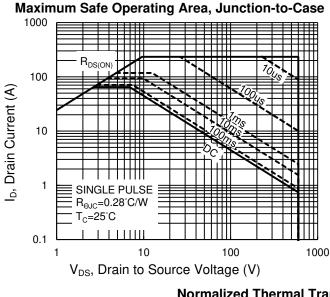


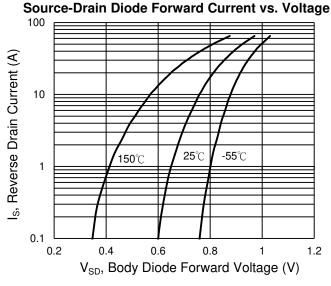
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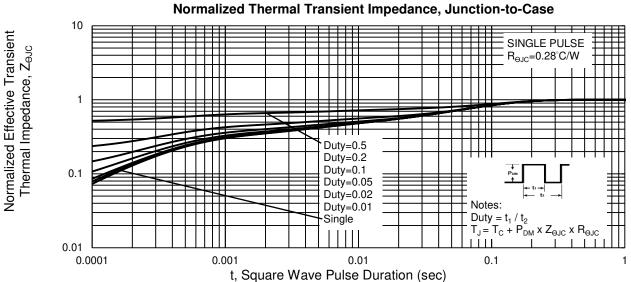
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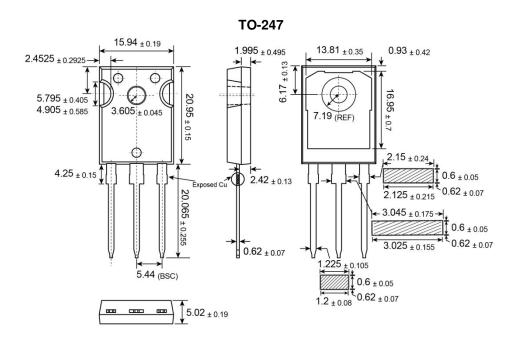


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# PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



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# **MARKING DIAGRAM**



**G** = Halogen Free

Y = Year Code

**WW** = Week Code  $(01 \sim 52)$ 

F = Factory Code



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